

Monday (May 23, 2025)				Tuesday (May 24, 2025)				Wednesday (May 25, 2025)				Thursday (May 26, 2025)			
Technical Forum Breakfast				Technical Forum Breakfast				TAC Breakfast Meetings				Technical Forum Breakfast			
7:00 AM				7:00 AM				7:00 AM				7:00 AM			
<p>7:00 AM - 7:30 AM: Registration and Welcome</p> <p>7:30 AM - 8:00 AM: Keynote: Industry Outlook and Challenges</p> <p>8:00 AM - 8:30 AM: Session 1: Manufacturing in Space</p> <p>8:30 AM - 9:00 AM: Session 2: Protective, Tribological and Decorative Coatings</p> <p>9:00 AM - 9:30 AM: Session 3: Transport Conductor Materials (TCM)</p> <p>9:30 AM - 10:00 AM: Session 4: Atmospheric Plasma Technology</p> <p>10:00 AM - 10:30 AM: Session 5: Thin Film Processing of Organic Coatings</p> <p>10:30 AM - 11:00 AM: Session 6: Surface Engineering for the Hydrogen Economy</p> <p>11:00 AM - 11:30 AM: Session 7: Plasma Processing of Organic Coatings</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>7:00 AM - 7:30 AM: Registration and Welcome</p> <p>7:30 AM - 8:00 AM: Keynote: Industry Outlook and Challenges</p> <p>8:00 AM - 8:30 AM: Session 1: Industrial Challenges: Light, Heat, & Corrosion</p> <p>8:30 AM - 9:00 AM: Session 2: Thin Film Processing of Organic Coatings</p> <p>9:00 AM - 9:30 AM: Session 3: Protective, Tribological and Decorative Coatings</p> <p>9:30 AM - 10:00 AM: Session 4: Energy Conversion and Storage</p> <p>10:00 AM - 10:30 AM: Session 5: Thin Film Processing of Organic Coatings</p> <p>10:30 AM - 11:00 AM: Session 6: Surface Engineering for the Hydrogen Economy</p> <p>11:00 AM - 11:30 AM: Session 7: Plasma Processing of Organic Coatings</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>7:00 AM - 7:30 AM: Registration and Welcome</p> <p>7:30 AM - 8:00 AM: Keynote: Industry Outlook and Challenges</p> <p>8:00 AM - 8:30 AM: Session 1: Digital Transformation through Artificial Intelligence, Machine Learning, Simulation, and VR/AR</p> <p>8:30 AM - 9:00 AM: Session 2: Process Monitoring, Control, and Automation</p> <p>9:00 AM - 9:30 AM: Session 3: Atomic Layer Processing (ALP)</p> <p>9:30 AM - 10:00 AM: Session 4: High Power Impulse Magnetron Sputtering, and (2) Thin Film Contributions for the Hydrogen Economy</p> <p>10:00 AM - 10:30 AM: Session 5: Coatings and Processes for Biomedical Applications</p> <p>10:30 AM - 11:00 AM: Session 6: Optical Coatings</p> <p>11:00 AM - 11:30 AM: Session 7: Coatings for Energy Conversion and Related Processes</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>7:00 AM - 7:30 AM: Registration and Welcome</p> <p>7:30 AM - 8:00 AM: Keynote: Industry Outlook and Challenges</p> <p>8:00 AM - 8:30 AM: Session 1: Digital Transformation of Industrial Deposition Processes</p> <p>8:30 AM - 9:00 AM: Session 2: Thin Film Processing of Organic Coatings</p> <p>9:00 AM - 9:30 AM: Session 3: Protective, Tribological and Decorative Coatings</p> <p>9:30 AM - 10:00 AM: Session 4: Energy Conversion and Storage</p> <p>10:00 AM - 10:30 AM: Session 5: Thin Film Processing of Organic Coatings</p> <p>10:30 AM - 11:00 AM: Session 6: Surface Engineering for the Hydrogen Economy</p> <p>11:00 AM - 11:30 AM: Session 7: Plasma Processing of Organic Coatings</p> <p>11:30 AM - 12:00 PM: Lunch</p>			
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<p>8:00 AM - 8:30 AM: Session 8: Plasma Processing of Organic Coatings</p> <p>8:30 AM - 9:00 AM: Session 9: Protective, Tribological and Decorative Coatings</p> <p>9:00 AM - 9:30 AM: Session 10: Energy Conversion and Storage</p> <p>9:30 AM - 10:00 AM: Session 11: Thin Film Processing of Organic Coatings</p> <p>10:00 AM - 10:30 AM: Session 12: Surface Engineering for the Hydrogen Economy</p> <p>10:30 AM - 11:00 AM: Session 13: Plasma Processing of Organic Coatings</p> <p>11:00 AM - 11:30 AM: Session 14: Protective, Tribological and Decorative Coatings</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>8:00 AM - 8:30 AM: Session 15: Plasma Processing of Organic Coatings</p> <p>8:30 AM - 9:00 AM: Session 16: Protective, Tribological and Decorative Coatings</p> <p>9:00 AM - 9:30 AM: Session 17: Energy Conversion and Storage</p> <p>9:30 AM - 10:00 AM: Session 18: Thin Film Processing of Organic Coatings</p> <p>10:00 AM - 10:30 AM: Session 19: Surface Engineering for the Hydrogen Economy</p> <p>10:30 AM - 11:00 AM: Session 20: Plasma Processing of Organic Coatings</p> <p>11:00 AM - 11:30 AM: Session 21: Protective, Tribological and Decorative Coatings</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>8:00 AM - 8:30 AM: Session 22: Quantum Computing, and (2) Organic and Perovskite Electronics</p> <p>8:30 AM - 9:00 AM: Session 23: Plasma Processing and Diagnostics</p> <p>9:00 AM - 9:30 AM: Session 24: Thin Film Sensors, (1) Emerging and Transitional Technologies, Applications, Large Scale Growth and Advanced Characterization, and (2) Wafer-Fab Roll-to-Roll Technologies and Innovation</p> <p>9:30 AM - 10:00 AM: Session 25: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>10:00 AM - 10:30 AM: Session 26: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>10:30 AM - 11:00 AM: Session 27: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>11:00 AM - 11:30 AM: Session 28: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>11:30 AM - 12:00 PM: Lunch</p>				<p>8:00 AM - 8:30 AM: Session 29: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>8:30 AM - 9:00 AM: Session 30: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>9:00 AM - 9:30 AM: Session 31: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>9:30 AM - 10:00 AM: Session 32: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>10:00 AM - 10:30 AM: Session 33: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>10:30 AM - 11:00 AM: Session 34: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>11:00 AM - 11:30 AM: Session 35: Plasma Processing, (2) Two Dimensional (2D) Materials and Nanostructures, Applications, Large Scale Growth and Advanced Characterization, and (3) Selective Atomic Scale Processes</p> <p>11:30 AM - 12:00 PM: Lunch</p>			
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